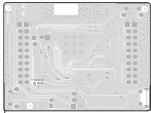
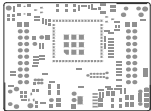


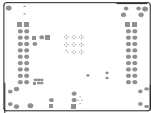
ALL NETWORKS DERIVED FROM TOP SIZE	BOMID IN: 1010041	REV: A	SAN REV: Not In VersionControl
LAYER NAME = 1010041			
PLOT NAME = Top Layer	SCHEDULED: 1/2/2019	11:36:44 AM	TECHS INSTRUMENTS



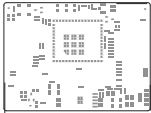
ALL NETWORKS DERIVED FROM TOP SIZE.	BOMID IN: 1010041	RCN IN	SAN RCN Not In: VersionControl
LAYER NAME = LASER-ETCHED LAYER			
PLOT NAME = Bottom Layer	SCHEDULED : 7/26/2019	11:36:49 AM	TECHS INSTRUMENTS



ALL NETWORKS USED FROM TOP SIZE	SHEET NO. 101004	REV. A	SUN REV. Rev 2n VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask Dn Dm	SCHEDULED = 7/26/2019	11:36:49 AM	TECHS INSTRUMENTS



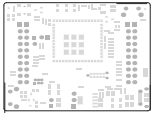
ALL NETWORK LAYERS FROM TOP SIZE	BOARD IN: 101004	REV: A	SUN REV: Not in VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask Dv101	GENERATED: 1/7/2019	11:36:05 AM	TECHS: INSTRUMENTS



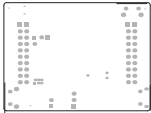
ALL METWORK USED FROM TOP SIZE	SHEET NO. 101004	REV. A	SUN REV. 2in. VersionControl
LAYER NAME = Top Plate			
PLOT NAME = Top Plate Rev. A.dwg	SCHEDULED = 7/26/2019	11:36:59 AM	TECHS INSTRUMENTS



ALL NETWORKS USED FROM TOP SIZE	SOUND IN: YES/NO	RCN IN	SUN RCN Not In VersionControl
LAYER NAME = Bottom Plate			
PLOT NAME = Bottom Plate Peak Print	SCHEDULED = 7/26/2019	11:36:55 AM	TECHS INSTRUMENTS

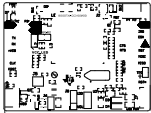


ALL NETWORKS USED FROM TOP SIZE	SOUND IN YES/NO	REIN A	SUN REIN Not In VersionControl
LAYER NAME	SCHEDULED	1/24/2019	11:36:57 AM
PLAT NAME - Top Pad Header			TECHS INSTRUMENTS

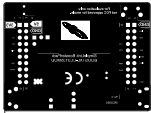


ALL METADATA USED FROM TOP SIZE	SOUND IN HELIX04	RCN A	SUN RCN Not In VersionControl
LAYER NAME =			
PLOT NAME = Bottom Rad Meter	SCHEDULED	1/24/2019	11:36:59 AM
TECHS INSTRUMENTS			





ALL NETWORK LAYERS FROM TOP SIZE	BOARD IN: 10.0004	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Silkscreen Overlay	SCHEDULED: 1/2/2019	11:30:05 AM	TECHS INSTRUMENTS

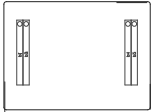


ALL METRICS USED FROM TOP SIDE	BOARD IN HOLD	RCN A	SUN REC Not In VersionControl
LAYER NAME = Bottom Overlay			
PLAT NAME = Bottom Silkscreen Overlay	SCHEDULED	7/26/2019	11:30:09 AM
		TECHS INSTRUMENTS	

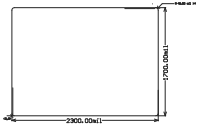
201 \*New assembly are P00 symbols, P00 procedures will be observed.  
202 \*New assembly that in case and new that are all components that at no case that is not acceptable.  
203 \*New assembly that ready with currently accepted P00-000 Case 5, unless otherwise specified.



COMPONENTS MARKED "DNP" SHOULD NOT BE POPULATED. ASSEMBLY OPERATES THE Variation(s)			
PCB USED FOR TOP SIDE	BOARD NUMBER	REV. A	SUN REV. Not In VersionControl
RS Assembly Top			
PLAT MPYC +RS Assembly Top	SCHEDULED	1/26/2019	11:30:05 AM
			TECHS INSTRUMENTS



COMPONENT IDENTIFICATION			
Part Name: 100-1000-1000			
Part Number: 100-1000-1000		Revision: 1.0	
Assembly Instructions			
1. Assemble the component as shown in the drawing.		2. Check the dimensions and tolerances.	
3. Test the component for proper operation.		4. Record the test results.	



C:\1000.00mm\1000.00mm			
ALL AUTOSAVE FILED FROM TOP SIZE	BOARD IN: 1000.00mm	REV: A	SUN REV: Not in VersionControl
LAYER NAME: 1			
PLOT NAME: 100 Board Dimensions	SCHEDULED: 1/24/2019	11:30:07 AM	TECHS INSTRUMENTS

Layer	Material	Thickness	Constant	Board Layer	Notes
1	Copper	0.0015	0.0015	1	Top Layer
2	Solder	0.0015	0.0015	2	Top Layer
3	Copper	0.0015	0.0015	3	Top Layer
4	Copper	0.0015	0.0015	4	Top Layer
5	Copper	0.0015	0.0015	5	Top Layer
6	Copper	0.0015	0.0015	6	Top Layer
7	Copper	0.0015	0.0015	7	Top Layer
8	Copper	0.0015	0.0015	8	Top Layer
9	Copper	0.0015	0.0015	9	Top Layer
10	Copper	0.0015	0.0015	10	Top Layer
11	Copper	0.0015	0.0015	11	Top Layer
12	Copper	0.0015	0.0015	12	Top Layer
13	Copper	0.0015	0.0015	13	Top Layer
14	Copper	0.0015	0.0015	14	Top Layer
15	Copper	0.0015	0.0015	15	Top Layer
16	Copper	0.0015	0.0015	16	Top Layer
17	Copper	0.0015	0.0015	17	Top Layer
18	Copper	0.0015	0.0015	18	Top Layer
19	Copper	0.0015	0.0015	19	Top Layer
20	Copper	0.0015	0.0015	20	Top Layer
21	Copper	0.0015	0.0015	21	Top Layer
22	Copper	0.0015	0.0015	22	Top Layer
23	Copper	0.0015	0.0015	23	Top Layer
24	Copper	0.0015	0.0015	24	Top Layer
25	Copper	0.0015	0.0015	25	Top Layer
26	Copper	0.0015	0.0015	26	Top Layer
27	Copper	0.0015	0.0015	27	Top Layer
28	Copper	0.0015	0.0015	28	Top Layer
29	Copper	0.0015	0.0015	29	Top Layer
30	Copper	0.0015	0.0015	30	Top Layer
31	Copper	0.0015	0.0015	31	Top Layer
32	Copper	0.0015	0.0015	32	Top Layer
33	Copper	0.0015	0.0015	33	Top Layer
34	Copper	0.0015	0.0015	34	Top Layer
35	Copper	0.0015	0.0015	35	Top Layer
36	Copper	0.0015	0.0015	36	Top Layer
37	Copper	0.0015	0.0015	37	Top Layer
38	Copper	0.0015	0.0015	38	Top Layer
39	Copper	0.0015	0.0015	39	Top Layer
40	Copper	0.0015	0.0015	40	Top Layer
41	Copper	0.0015	0.0015	41	Top Layer
42	Copper	0.0015	0.0015	42	Top Layer
43	Copper	0.0015	0.0015	43	Top Layer
44	Copper	0.0015	0.0015	44	Top Layer
45	Copper	0.0015	0.0015	45	Top Layer
46	Copper	0.0015	0.0015	46	Top Layer
47	Copper	0.0015	0.0015	47	Top Layer
48	Copper	0.0015	0.0015	48	Top Layer
49	Copper	0.0015	0.0015	49	Top Layer
50	Copper	0.0015	0.0015	50	Top Layer
51	Copper	0.0015	0.0015	51	Top Layer
52	Copper	0.0015	0.0015	52	Top Layer
53	Copper	0.0015	0.0015	53	Top Layer
54	Copper	0.0015	0.0015	54	Top Layer
55	Copper	0.0015	0.0015	55	Top Layer
56	Copper	0.0015	0.0015	56	Top Layer
57	Copper	0.0015	0.0015	57	Top Layer
58	Copper	0.0015	0.0015	58	Top Layer
59	Copper	0.0015	0.0015	59	Top Layer
60	Copper	0.0015	0.0015	60	Top Layer
61	Copper	0.0015	0.0015	61	Top Layer
62	Copper	0.0015	0.0015	62	Top Layer
63	Copper	0.0015	0.0015	63	Top Layer
64	Copper	0.0015	0.0015	64	Top Layer
65	Copper	0.0015	0.0015	65	Top